Silicon Switching Diode

1N914 or 1N914-1

DO-35 Glass Package

Applications

Used in general purpose applications, where performance and switching speed are important.

Features

- Six sigma quality
- Metallurgically bonded
- BKC's Sigma Bond™ plating for problem free solderability
- LL-34/35 MELF SMD available
- Full approval to Mil-S-19500/116
- Available up to JANTXV levels
- "S" level screening available to SCDs

DO-35 Glass Package	
25.4 mm 0.120-200" (Min.) 3.05-5.08-mm	Lead Dia. 0.018-0.022" 0.458-0.558 mm Dia. 0.06-0.09" 1.53-2.28 mm

Maximum Ratings	Symbol	Value	Unit
Peak Inverse Voltage	PIV	100 (Min.)	Volts
Average Rectified Current	l _{Avg}	75	mAmps
Continuous Forward Current	l _{Fdc}	300	mAmps
Peak Surge Current (t _{peak} = 1 sec.)	 peak	0.5	Amp
Power Dissipation @ $T_L=50$ °C, L = 3/8" from body	P _{tot}	250	mWatts
Storage & Operating Temperature Range	T _{St & Op}	-65 to +200	°C

Electrical Characteristics @ 25 °C*	Symbol	Absolute Limits	Unit	
Breakdown Voltage @ Ir = 0.1 mA	PIV	100 (Min)	Volts	
Reverse Leakage Current @ V _R = 20 V	I _R	0.025 (Max)	μA	
Reverse Leakage (Vr =20 V, 150 °C)	I _R	50 (Max)	μA	
Reverse Leakage Current @ V _R = 75 V	I _R	5.0 (Max)	μA	
Capacitance @ $V_R = 0 V$, $f = 1 mHz$	C_{T}	4.0 (Max)	pF	
Reverse Recovery Time (note 1)	t _{rr}	4.0 (Max)	nSecs	
Forward Recovery Time (note 2)	V_{fr}	2.5 (Max)	Volts	

Note 1: $I_F = 10$ mA, $R_L = 100$ Ohms, Vr = 6.0 Volts , Irr = 1.0 mA

Note 2: $I_{E} = 50 \text{ mA dc}$

*UNLESS OTHERWISE SPECIFIED

